

3-928776-2

✓ ACTIVE

AMPMODU | AMPMODU Headers

TE Internal #: 3-928776-2

Connector Contact, Pin, Wire-to-Board, Tin, Pallet, Printed Circuit Board, 5 A, Signal, Board Mount, -85 – 257 °F [-65 – 125 °C],
AMPMODU Headers

[View on TE.com >](#)[Connectors > PCB Connectors > Wire-to-Board Connectors > Wire-to-Board Connector Contacts](#)Contact Type: **Pin**Connector System: **Wire-to-Board**Contact Mating Area Plating Material: **Tin**Packaging Method: **Pallet**Connector & Contact Terminates To: **Printed Circuit Board****Features****Product Type Features**

Applied Pressure	Standard
Connector System	Wire-to-Board
Connector & Contact Terminates To	Printed Circuit Board

Contact Features

Mating Square Post Dimension	.64 mm[.025 in]
Contact Shape & Form	Round
Contact Orientation	Straight
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Type	Pin
Contact Mating Area Plating Material	Tin
Contact Current Rating (Max)	5 A

Termination Features

Rectangular Termination Post & Tail Thickness	.64 mm[.025 in]
Rectangular Termination Post & Tail Width	.71 mm[.027 in]
Termination Method to Printed Circuit Board	Through Hole - Press-Fit

Mechanical Attachment

Connector Mounting Type

Board Mount

Usage Conditions

Operating Temperature Range

-65 – 125 °C [-85 – 257 °F]

Operation/Application

Circuit Application

Signal

Packaging Features

Packaging Quantity

30000

Packaging Method

Pallet

Product Compliance

For compliance documentation, visit the product page on [TE.com](https://te.com)>

EU RoHS Directive 2011/65/EU

Compliant

EU ELV Directive 2000/53/EC

Compliant

China RoHS 2 Directive MIIT Order No 32, 2016

No Restricted Materials Above Threshold

EU REACH Regulation (EC) No. 1907/2006

Current ECHA Candidate List: JUNE 2023
(235)Candidate List Declared Against: JUNE
2023 (235)

Does not contain REACH SVHC

Halogen Content

Low Halogen - Br, Cl, F, I < 900 ppm per
homogenous material. Also BFR/CFR/PVC
Free

Solder Process Capability

Not applicable for solder process capability

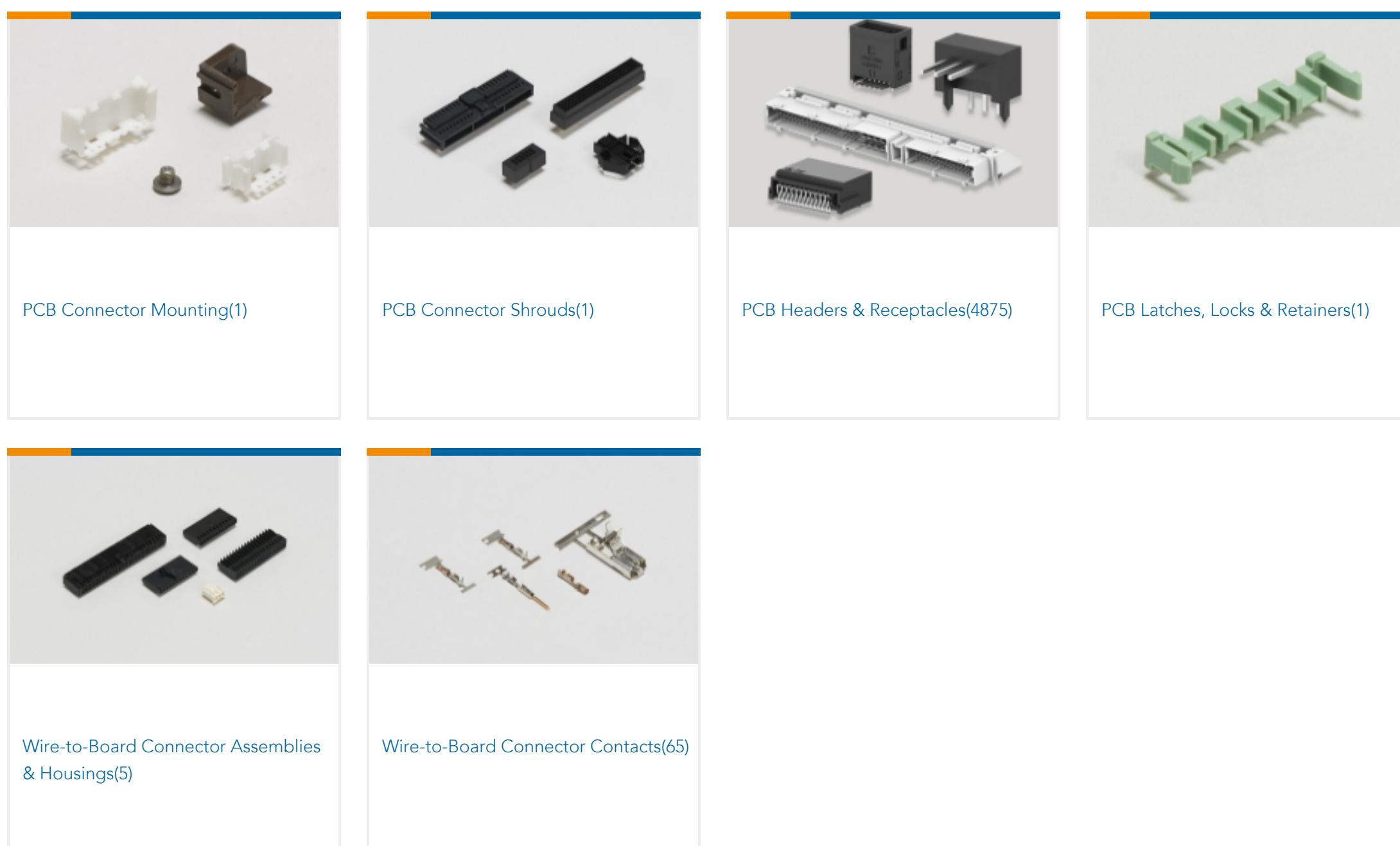
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

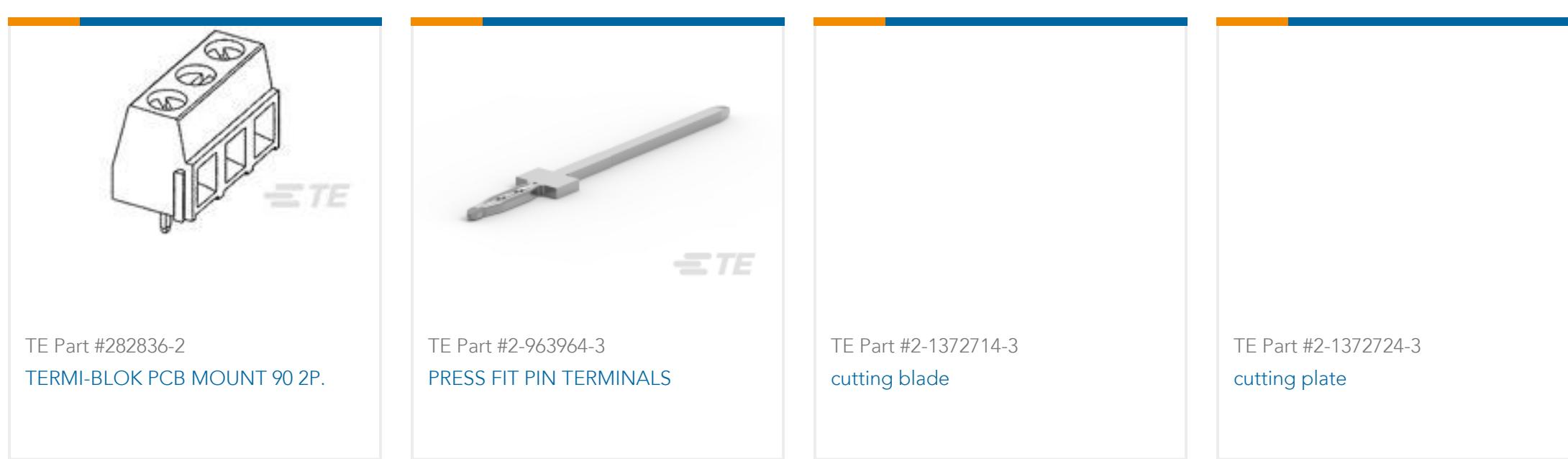
Compatible Parts

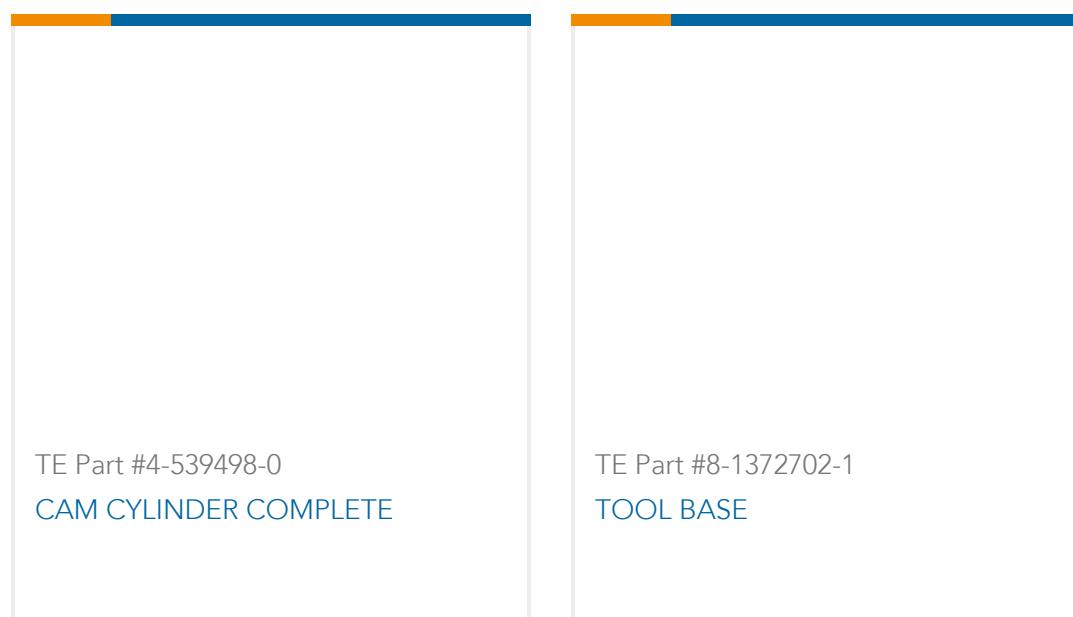


Also in the Series | AMPMODU Headers



Customers Also Bought





Documents

CAD Files

3D PDF

3D

Customer View Model

[ENG_CVM_CVM_3-928776-2_Y.2d_dxf.zip](#)

English

Customer View Model

[ENG_CVM_CVM_3-928776-2_Y.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_3-928776-2_Y.3d_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Datasheets & Catalog Pages

[AMPMODU Interconnection System](#)

[AMPMODU Interconnection System](#)

English